PRODUCT SPECIFICATION

SCOPE

vers the performance requirements for the AMP* low profile strip recent cle, used to provide a quick disconnect between flexible flat cable and a printed circuit board or similar panel.

Arrangement 1.2.

Strip receptacles provide a . 100 centerline spacing, inline contact arrangement for solder mounting to a printed circuit board.

Design 1.3.

Receptacles are designed to mate with FFC solder tabs terminated to flat conductor cable. The solder tabs shall be within the following dimensional limits: thickness, .008 - .011 inch; maximum width, .030 inch; mating length, . 100 minimum to . 150 maximum. Receptacles shall accept any tab length providing they are controlled to engage the receptacles within the specified mating length.

Oualification 1.4.

AMP Low Profile Strip Receptacles

Assemblies shall meet the requirements of AMP Specification 108-9029, Low Profile DIP Receptacle.

AMP Flexible Flat Conductor Cable Contacts

Flexible flat cable and terminated contact shall meet the requirements of AMP Specification 108-9024, Flexible Flat Conductor Cable.

Low Profile Strip Receptacle to Flexible Flat Cable Interconnect

When testing or inspecting the subject products as an interconnect system this document shall always be supported by the applicable product drawing and by AMP Specification 109-9000, Packaging Components Division Connector Test Methods. In case of conflict the order of document precedence is as follows:

- (1) Product Drawing
- This Product Specification (2)
- (3) 109-9000: Packaging Components Division Connector Test Methods

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				ļ <u>.</u>	SHEET	NAME INTERCONI	NECT, LO	W PROFILE STRIP
01 5 T					1 OF 4	RECEPT	ACLE TO	FLEXIBLE FLAT
25	LTR	REVISION RECORD	APP	DATE		CA	BLE SOL	DER TABS
AMP 12	250~13	REV 7-78			•			

FOREIGN PATENTS AND/OR PATENTS PENDING

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APPLICABLE DOCUMENTS

- 2.1. Applicable portions of the following documents form a part of the manufacturing control of this product.
 - A. MIL-G-45264: Gold Plating, Electrodeposited
 - B. MIL-T-10727: Tin Plating, Electrodeposited
- 2.2. The following documents describe handling and use of this product:
 - 109-9000: Packaging Components Division Connector Test Methods
 - MIL-STD-1344: Test Methods for Electrical Connectors в.
- PERFORMANCE REQUIREMENTS
- 3.1. Ratings
 - Current: 1.5 amperes maximum per contact
 - Temperature: -55° to 105°C В.
- 3.2. Test Requirements and Procedures Summary

Test Description	Requirement	Procedure
Examination of Product	Meet requirements of drawing.	Dimensional and visual.
Connector Mating Force	12.0 ounces maximum average per contact.	Receptacle assembly with flexible flat cable shall be used for this test.
Termination Resistance, Low Level	.020 ohm maximum initial, .030 ohm maximum final.	50 mv maximum open circuit, 100 ma maximum short circuit.
Termination Resistance, Rated Current	.020 ohm maximum initial, .030 ohm maximum final.	1.5 amperes.
Connector Unmating Force	2.0 ounces minimum average per contact.	Receptacle assembly with flexible flat cable shall be used for this test.
Contact Separation Force	0.9 ounce minimum.	Check with minimum thickness gage .008.
Thermal Shock	No evidence of physical damage.	-55° to 105°C, 5 cycles.
Durability	No evidence of physical damage. Meet contact separation force.	25 mating and unmating cycles using typical flexible flat conductor cable contacts.

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INTERCONNECT, LOW PROFILE STRIP RECEPTACLE TO FLEXIBLE FLAT CABLE SOLDER TABS

Figure 1 (cont)

Test Description	Requirement	Procedure
Vibration	No interruption of continuity greater than 1 microsecond. No physical damage.	10-2000 Hz; 15 G peak; mated; energized with 100 milliamperes dc current.
Physical Stack	No interruption of continuity greater than 1 microsecond. No physical damage.	100 G peak, 6 milliseconds sawtooth; mated; energized with 100 milliamperes dc current.
Humidity, Steady State	Termination resistance, low level and rated current, final.	90-95% RH, 40°C, 96 hours.
Salt Spray (Corrosion)	Termination resistance, low level and rated current, final.	5% solution, 48 hours.
Industrial Gas, (Corrosion)	Termination resistance, low level and rated current, final.	SO ₂ environment, 24 hours

Figure 1 (end)

3.3. Connector Tests and Sequence

	MIL-STD-1344	109-9000	Test Sequence(a)	
Test or Examination	Method	Requirement Paragraph	1	2
Examination of Product		5.1.	Х	X
Connector Mating Force	2013.1	5.8.		X
Termination Resistance, Low Level (c)	3002.1	5.2.	х	Х
Termination Resistance, Rated Current (c)	3004.1	5.3.	х	X
Connector Unmating Force	2013.1	5.9.	X	X
Contact Separation Force (d)	2014	5.7.	X	X
Temperature Cycling (b)	1003.1, Cond A	5.11.	X	X
Durability Contact Separation Force	2016	5,10.	X X	X
Vibratio n	2005.1, Cond III	5.12.	X	
Physical Shock	2004.1, Cond G	5, 13.	X	X
Humidity (e)	1002.2, Cond B	5, 14,	X	
Salt Spray (Corrosion) (f) (g)	1001.1, Cond B	5.15.B.		X
Industrial Gas (Corrosion) (f) (g)		5.15.A.		X

- (a) Samples are mounted on PC board.
- (b) Upper temperature limit 105°C.
- (c) See Figure 4.
- (d) See Figure 3.
- (e) Tin plated contacts only.
- (f) Gold plated contacts only.
- (g) One half the test samples shall be subjected to salt spray and the other half to industrial gas.

Figure 2

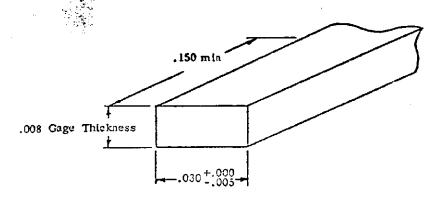
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INTERCONNECT, LOW PROFILE STRIP RECEPTACLE TO FLEXIBLE FLAT CABLE SOLDER TABS

3.4. Selection of Test Samples

Test samples shall consist of 2 connectors of each material and plating finish.



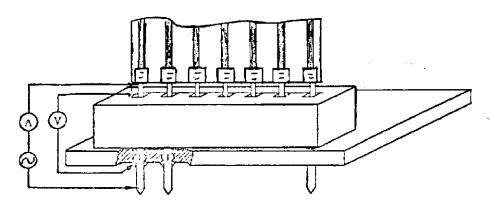
Notes: 1. Break all edges. .002 +.001 R max

2. Provide 4 microinch finish.

3. Material: Tool steel, hardness to Rockwell C60-65.

Figure 3

Withdrawal Gage



Note: Measure resistance as close as possible to socket.

Figure 4

Termination Resistance

